

Dynasolve 180



Cured Polymer Cleaning Solvent



Dynasolve 180 is a cleaning solvent that is used for removing cured urethane, crystallized isocyanate, and cured epoxy. It is used in a broad variety of electronic and industrial cleaning applications.

CLEANING APPLICATIONS:

Industrial urethane and epoxy removal and cleaning

Electronic urethane and epoxy removal and cleaning

Crystallized isocyanate cleaning

ADVANTAGES:

More efficient than acetone, MEK and other solvents

High resin loading capacity allows for reuse and reduced cost of ownership

High flash point

SPECIFICATIONS:

Specific gravity: 1.03

Boiling point: 395°F (202°C)

Flash point: 195°F (91°C)

MATERIALS REMOVED:

Cured urethane

Crystallized isocyanate

Cured epoxies

PRODUCT USAGE GUIDELINES

(SEE SDS FOR EH&S INFORMATION)

1. Immerse part in Dynasolve 180 at room temperature
 - Note: Cured epoxy requires heating to >200°F (<93°C)
2. Observe carefully. If cured material appears unaffected after 1 hour, heat solvent to 130°-150°F (55°-66°C).
3. If material appears unaffected after 2 hours, call Versum Materials Dynaloy for technical support.

MATERIAL COMPATIBILITY:

Recommended materials including:

All metals

Teflon®

Polyethylene, polypropylene and mylar

Avoid materials including:

Viton®

PVC

ABS



For more information, please contact us at:

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